



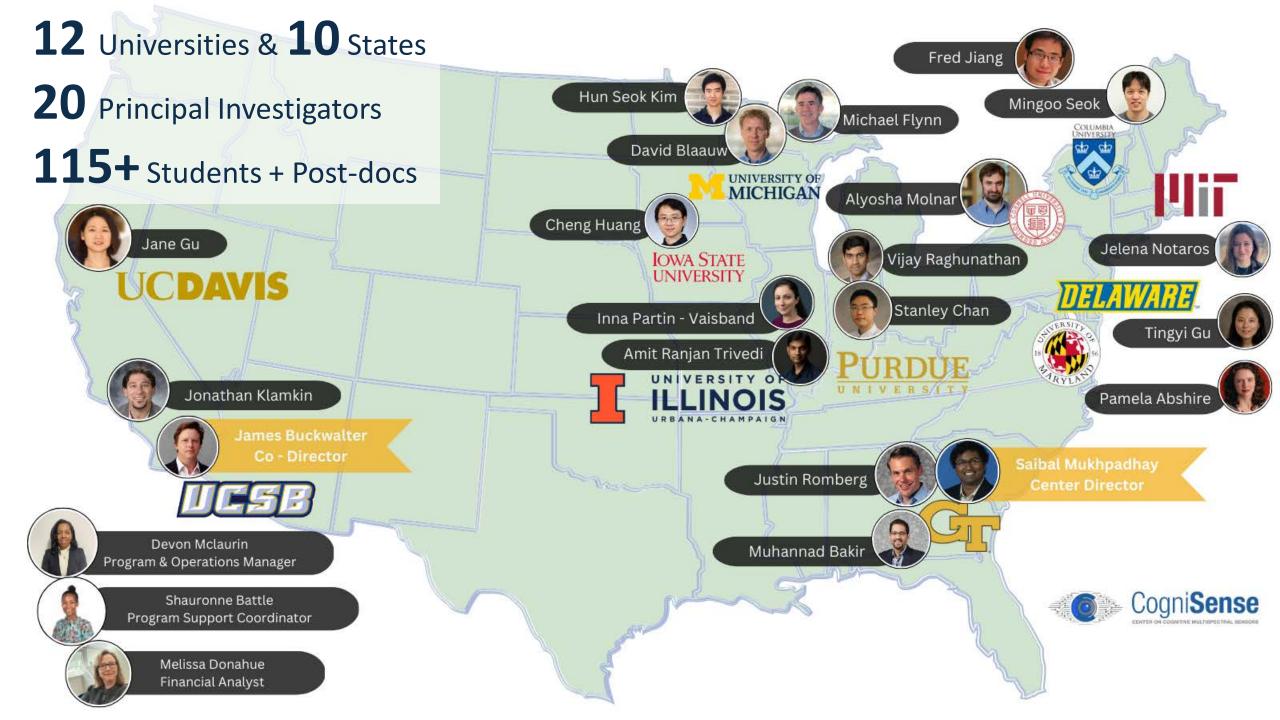


**CogniSense: Center on Cognitive Multispectral Sensors** 

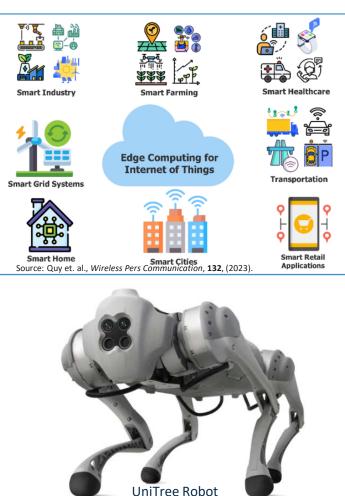
### **Center Overview and Highlights**

Director: Saibal Mukhopadhyay, Georgia Tech Co-Director: James Buckwalter, University of California, Santa Barbara

Georgia Institute of Technology, UC Santa Barbara, University of Michigan, University of Illinois Chicago, Columbia University, Purdue University, Cornell University, Massachusetts Institute of Technology, University of Maryland, University of Delaware, University of California, Davis, and Iowa State University,



## **Sensors Drive Intelligent Systems**





Source: https://www.techaheadcorp.com/blog/future-of-self-driving-cars/

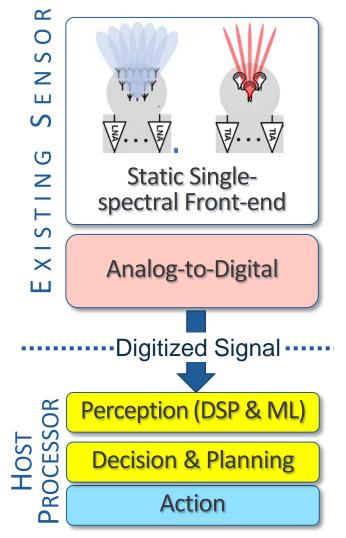




Source: Image generated using ChatGPT

Unobstructed sensing is critical to deploy autonomous platforms. 5RC 3

### Analog Data Deluge: A Key Challenge in Today's Sensors



SRC

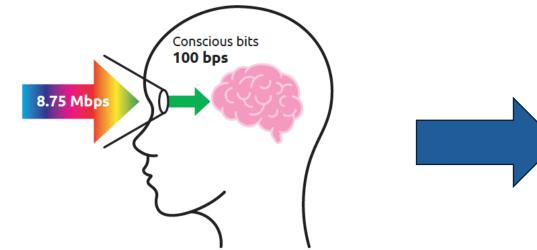
Wideband and multi-modal pixel arrays can provide highquality imaging for perception.

### Challenge:

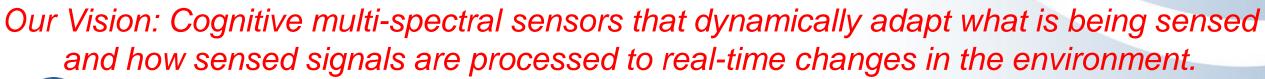
- Analog Data Deluge: Large volume of digitized data is continuously generated and transmitted from the sensors.
- **Power dissipation can be un-manageable.** Large power dissipation in many ADCs, I/O of the sensors, and downstream computation to process high-volume of sensor data.

# Power and data volume may ultimately limit the quality of perception that can be achieved.

## **Inspiration from Biology**



- The brain's ability to perceive and reason is based on ultra compressed sensing capabilities with 100,000 data reduction and a low operation power.
- Closed-loop feedback from the senses allows the brain to adapt the level of engagement and the depth of cognitive processing based on task demands.



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HOST

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Processing

Configurable Front-end

Analog-to-Feature

**Features** 

Perception (DSP & ML)

**Decision & Planning** 

Action

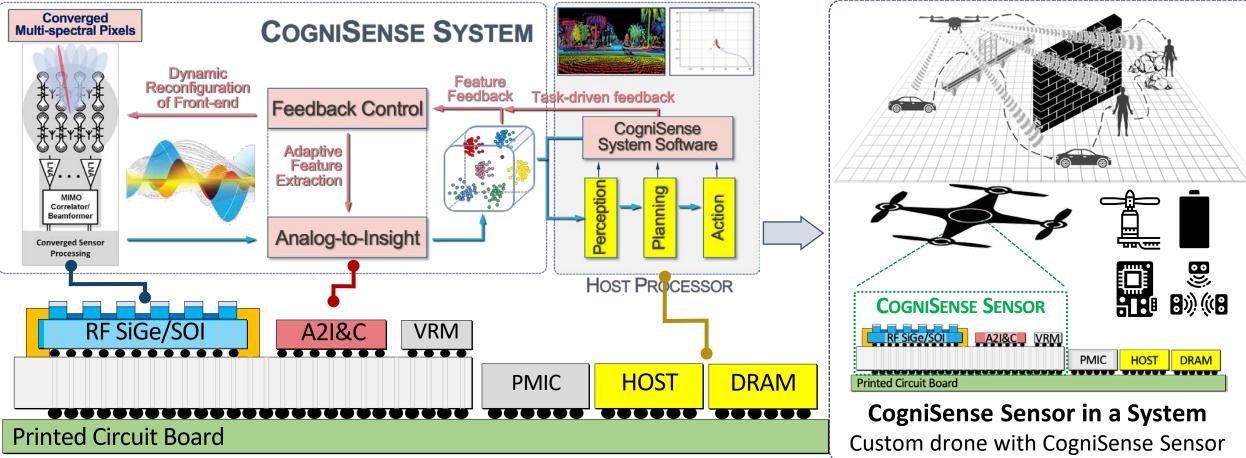




Feedback Control

## **CogniSense: Technology Overview**

### **COGNISENSE APPLICATIONS**

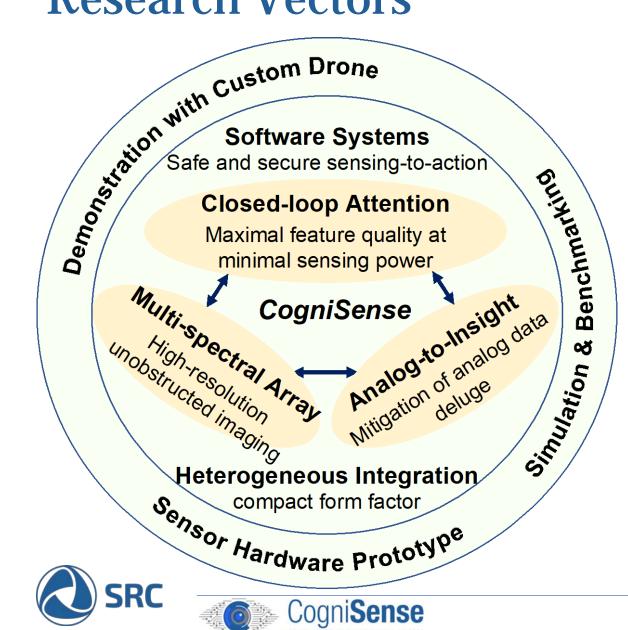


Cognitive multi-spectral sensors directly generate trustworthy insights from wideband multimodal analog signals using closed-loop feedback control of the sensor hardware and feature extraction algorithms that enable energy-efficient sensing-to-action.





## **Research Vectors**



**Thrust 1: Multi-spectral Pixel Array** 

Leaders: James Buckwalter & Jelena Notarose

Thrust 2: Analog-to-Insight Leaders: <u>Justin Romberg</u> & Hun-seok Kim

Thrust 3: Closed-loop Attention Leaders: Mingoo Seok & Alyosha Molnar

Thrust 4: Heterogeneous Integration Leaders: Inna Patin-Vaisband

Thrust 5: System Software & Integration Leaders: Amit Trivedi & Vijay Raghunathan

## **Research Highlights from Year 1**

#### Multi-spectral front-end & sensor integration

- Power-efficient 140GHz FMCW radar
- Beam-steering & switched beam Lidar
- High dynamic range passive imaging
- Front-end circuits for sensor convergence
- New power management circuits
- 3D HI (Cu-Cu bonding) optimized for electrical & thermal management in CogniSense sensor.

## Algorithms & Circuits for feature extraction and processing to reduce analog data

- Linear algorithm to extract features for analog signals.
- Multi-modal feature fusion and processing algorithms
- New compute-in-memory circuits for analog feature extraction, floating point operation, optimization, etc.
- Efficient hardware architecture for neural network.
- Fundamental analysis of sensor trade-offs.

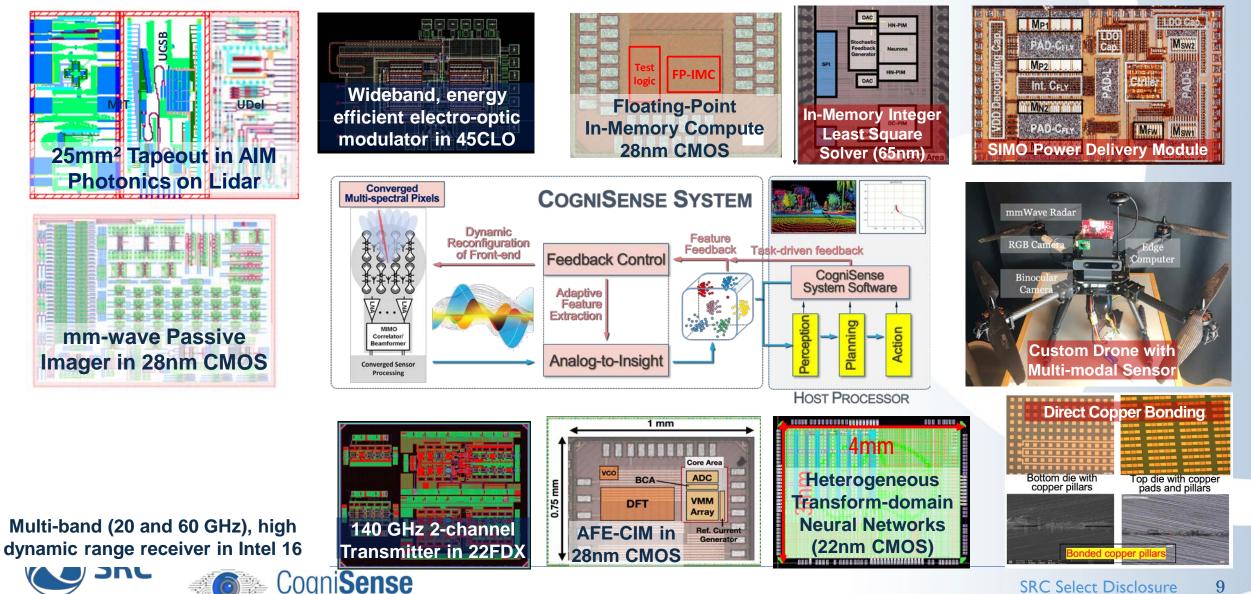
#### Cross-stack adaptation for power-quality trade-off in CogniSense sensing-to-action

- Uncertainty-aware sensor processing with trust and reputation tracking
- Adaptive on-sensor feature extraction algorithms for analog & multi-modal inputs
- New radar-based perception algorithms and task-dependent sensor control
- Security architecture for CogniSense sensors
- Multi-modal custom drone platform to study CogniSense concepts





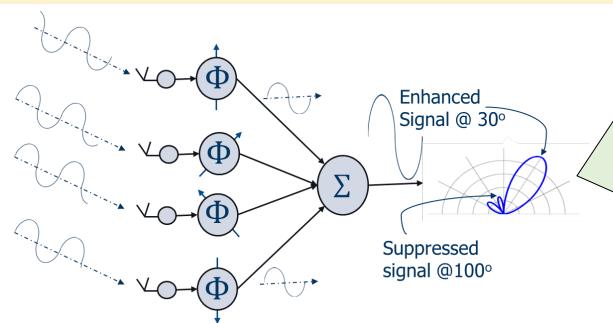
## **Research Highlights from Year 1**



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### Example of Mitigating Analog Data Deluge with Cognitive Sensing

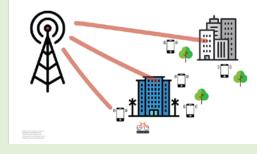
#### **Beamforming Receiver with Phased Array Sensor**



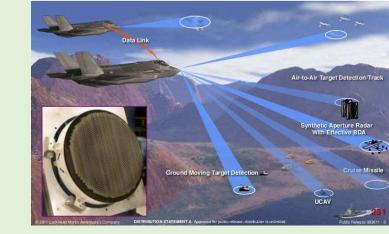
#### Missile Defense Systems (AN/FPS-115 PAWS Radar)



**5G Communications** 



#### Aircrafts (AESA Radar in F-35)



Beamforming: Adjust the phase and amplitude of signals from antenna array to generate an output beam.

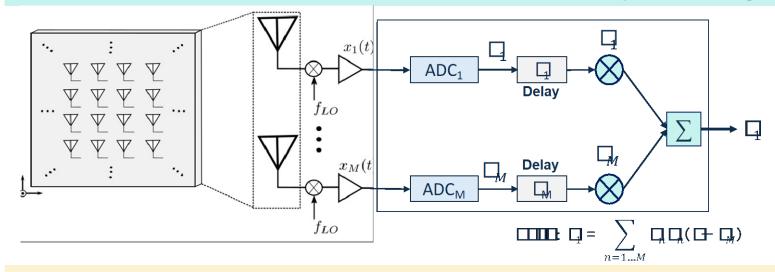
- Directional Selectivity
- Suppressed Interference/noise
- Improves SNR

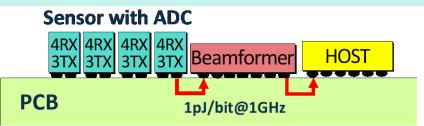




### **Example of Mitigating Analog Data Deluge with Cognitive Sensing**

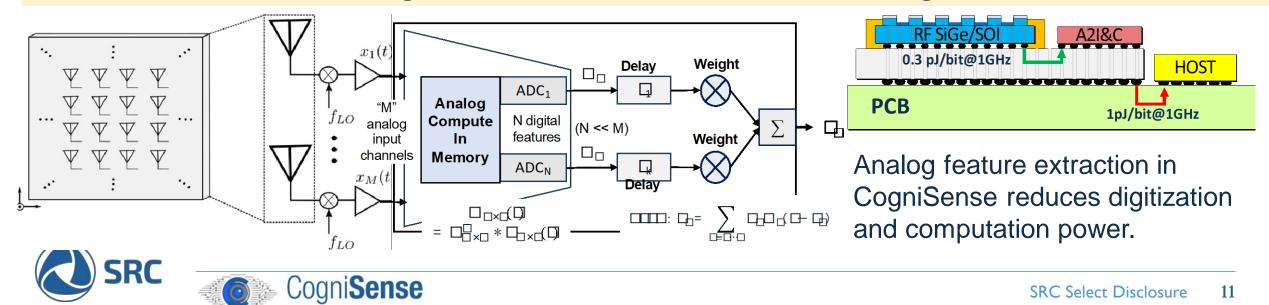
**Baseline: A True-Time Delay based Digital Beamformer** 



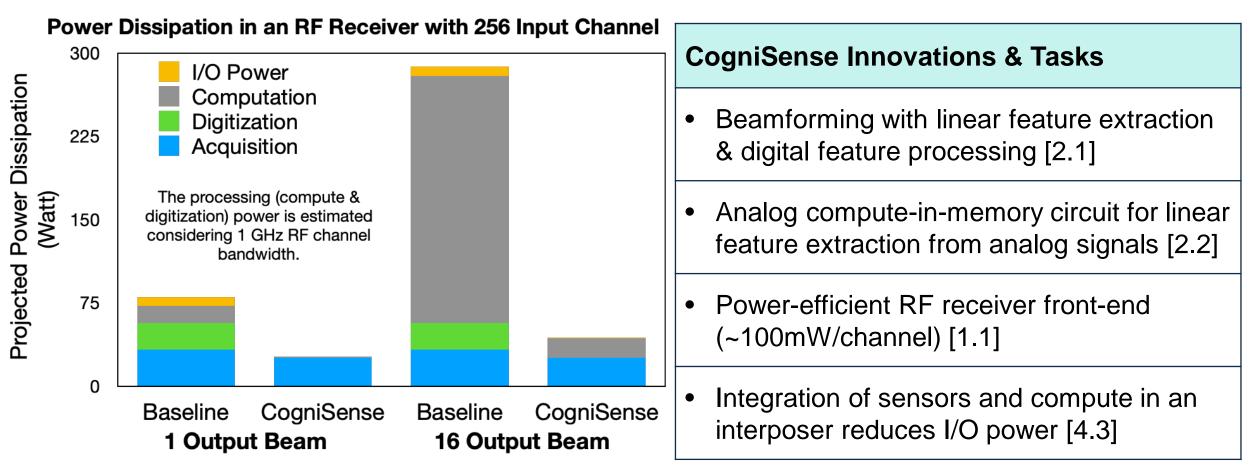


Digitization of wideband analog signals leads to high power dissipation in data converters and digital computation.

#### **CogniSense: Beamformer with Linear Embedding**



### Example of Mitigating Analog Data Deluge with Cognitive Sensing



### **Potential Impact**

- CogniSense sensor need 6.5X less power than the baseline for 16 beams.
- One can form > 200 beams with the power needed for 16 beams in the baseline.



Cogni**Sense** 



## **Key Plans of Actions in Year 2**

#### End-to-end simulation environment

- Radar and lidar-based input simulation
- Integrated software pipeline coupling algorithmic innovations across center
- Power/performance models to couple design innovations

#### System adaptation & sensing-to-action

- Define challenge application for case studies
- Emphasize system & software challenges like security

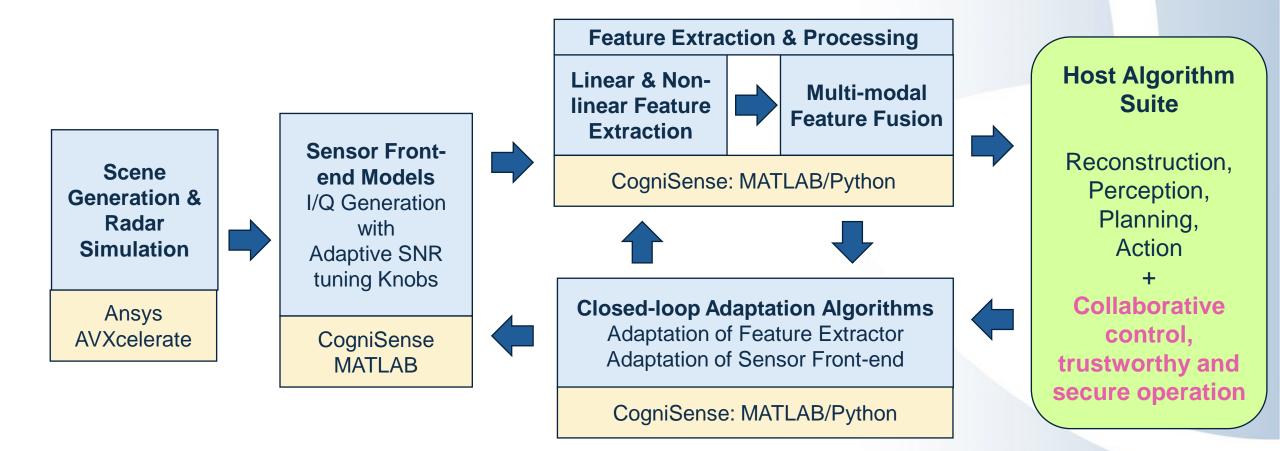
#### • Metrics & Benchmarking

- Establish thrust level metrics for sensing quality, analog data deluge, and adaptive power efficiency
- Evaluate progress of each component, sub-system, and sensing-to-action against metrics.



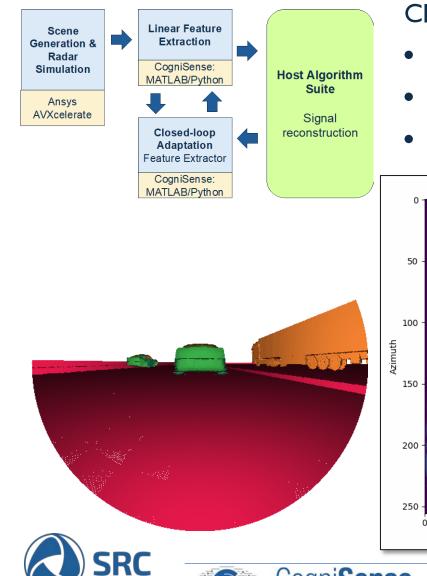


## **Key Plan of Action: Sensor Simulation Platform**



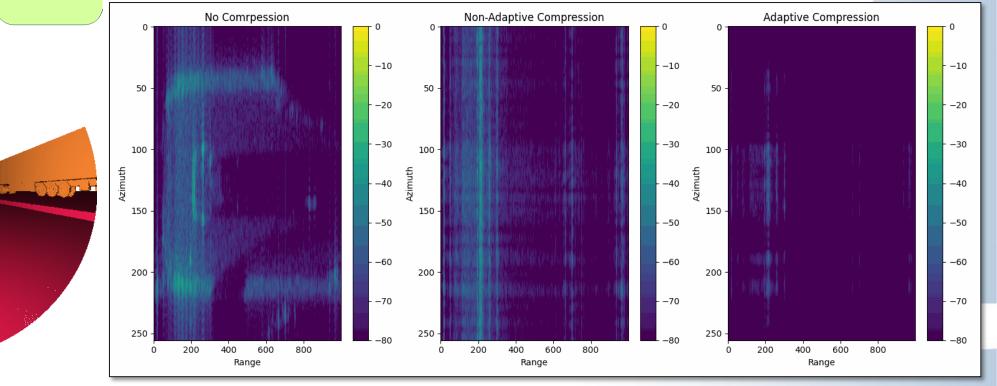


## **Sensor Modeling Platform: Scene to Feature**

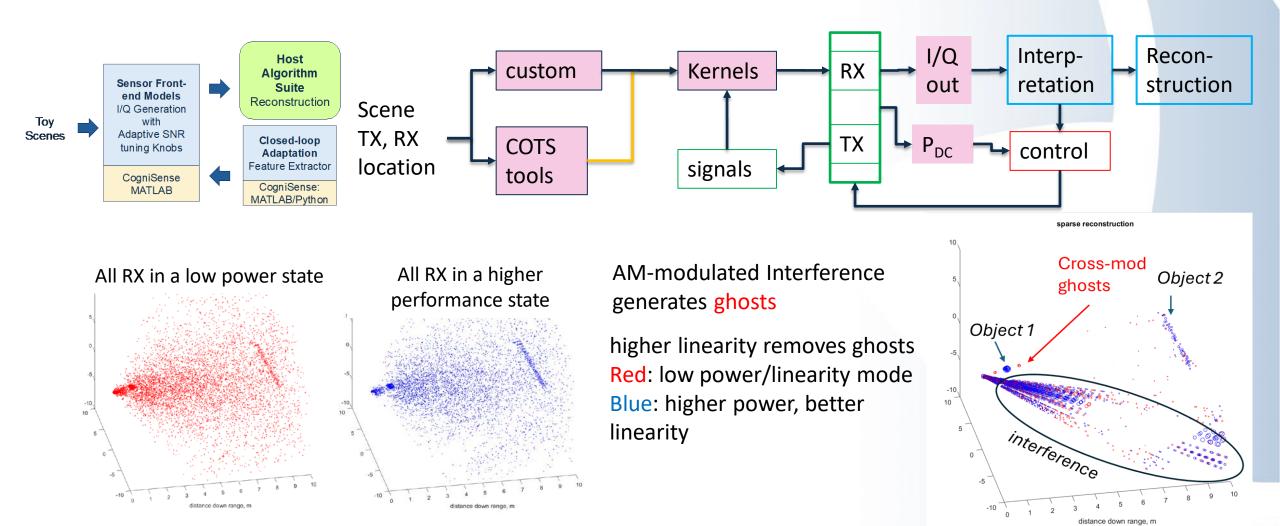


Closed-loop simulation with adaptive feature extraction:

- Front end: Ansys AVXelerate simulates 32x32 array @ 10 GHz BW
- 1024:16 (64x) compression using linear feature extraction
- Adaptive feature selection w/ update rate I kHz



### Sensor Modeling Platform: Effect of Sensor Hardware on Feature





## Key Plan of Action: System Hardware Modeling Platform

Power Performance Models for Sensor Modalities

FMCW Radar and Lidar Adaptive Power Management (Thrust 1) Link Models in Target HI Technologies

Signal Loss, Power Dissipation, Cross-talk, Bandwidth (Thrust 4) Power & Performance Models for Baseband Processing

Hardware accelerator models for feature extraction & on-line adaptation (Thrust 2 & 3)

CogniSense System Simulation & Design Space Exploration Tools

Thermal Models for HI Technology

Materials, Cooling technology (Thrust 4)

## SRC



#### System Design & Integration

HI Technology, Chiplet placements & routing options (Thrust 1 & 4)

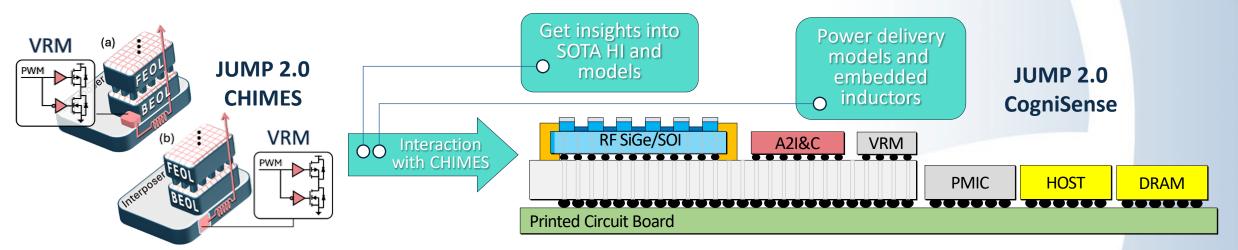
#### **CogniSense Power Delivery Models**

Inductor & capacitor, Interconnects Power loss, Power quality (Thrust 1 & 4)

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## System Hardware Modeling Plans



### 3DHI for Radar/LiDAR Integration and Simulation Approach:

- Reconstituted SiO2 tier (CHIMES technology)
- Encapsulate fabricated chiplets (AIM and GF photonics/RF processes) in oxide
- Exploit through oxide vias and RDL traces on the oxide for rewiring
- Direct copper bonding to simultaneously connect electrical and thermal I/Os **Performance target:** Acceptable junction temperature for a given power dissipation **Performance evaluation:**
- Simulate performance of thermal Cu bridge, Cu-Cu bonds, and heatsink bonding interface
- Simulate and model the heat flow from the chip to the package

#### Testbed:

- Passive, glass package stack (collaboration with prof. Buckwalter)
- Electrical characterization of the package, framework for passives and RFIC verification





### Power Management Driven Package Approach:

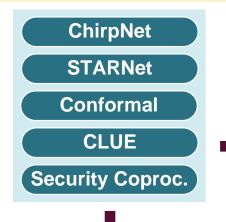
- Convert power with on-interposer VRM
- Stack advanced (28/16 nm) LV core devices with hybrid topology
- Utilize small, high-quality (L/R) interposerembedded inductors

#### Challenges and proposed solutions:

- Get access to GF 22FDX
- Transition to 22 nm and higher frequency VRMs
- Utilize commercial small-form-factor integratable on Si interposers power inductors (e.g., 0402)

### **Key Plan of Action: Demonstration & Benchmarking**

Algorithm Suite from Thrust-V for collaborative control, trustworthy and secure operation





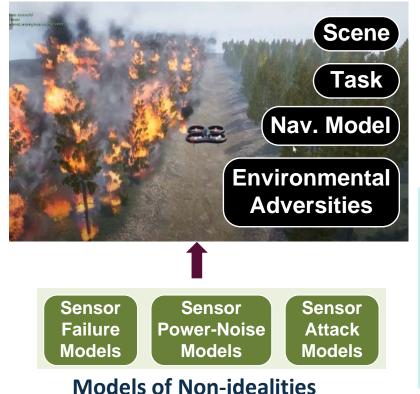
#### Backend hardware





Algorithms & Hardware Models of CogniSense Sensor (Thrust 1 to 4)

Simulation Environment for Grand Challenge Problem



On-going Discussions with Sponsors on Potential Approaches for Demonstration of CogniSense Concepts

#### **Custom Drone developed in CogniSense**



#### **COTS Platform Available at Georgia Tech**







UniTree Robot

**Boston Dynamics Spot** 

## **Key Plan of Action: Grand Challenge Application**



#### **Enable Search and Rescue Operations**

- Applications in civilian and military space.
- Multi-modal sensing is critical
  - mmWave Radar: see through obstacles; detect motion and materials;
  - Lidar: Enable 3D Vision; detect objects
  - Passive Imaging: Operate in smoke/fire
- Low-power is necessary for longer operation
- Closed-loop attention benefits operation in a dynamic environment.
- Application can be scaled to multiple platforms, each with multiple CogniSense sensors, to connect various innovations pursued within JUMP2.0.
- Feedback and guidance from members.



## **Needs (More) Attention in Year 2**

Center	Potential Topic of Interactions
<b>COCOSYS</b> Georgia Tech	Leverage prior experiences of CBRIC and COCOSYS centers on drone platforms and new AI/ML models
<b>CUbiC</b> Columbia	Joint work on photonics, optimizing signal processing pipelines, and exploring joint communication and sensing
ACE UIUC	Security aspects associated with distributed computing and sensing that are relevant to CogniSense
PRISM UCSD	Impact of new memory technology in design of feature extraction algorithms and exploring memory solutions for streaming sensor data.
CHIMES Penn State	Coordination of 3D-HI activities with CHIMES and incorporate new heterogeneous integration and advanced cooling solutions explored in CHIMES into the CogniSense platform.





### **Example: Cross-Center Collaborations**

**COGNISENSE – CUbiC** Photonic ASIC Integrated Accelerator



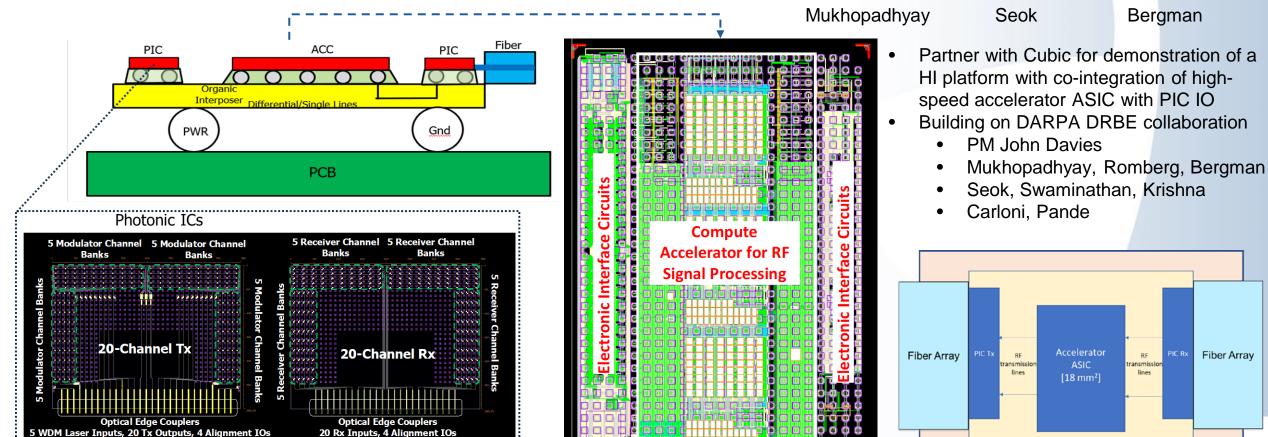


Organic Interposer Printed Circuit Board (PCB)



Bergman

PIC Rx





Fiber Arrav

## **Student Participation**

### Student participation

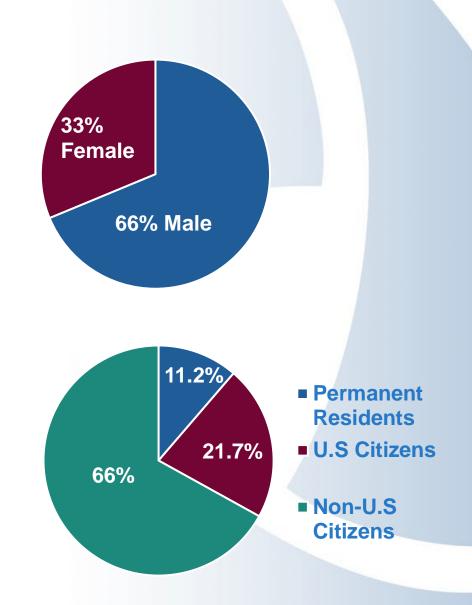
- 115 students/post-docs:
  - Primarily Graduate students (PHD and Masters)
  - Few Undergraduate Students (~5)
- 50+ students in the Annual Review

### Student-led publications

- 11 students participated in TECHCON2023
- 40+ Students papers

### CogniSense student in Members (2023)

- 6+ Students joined SRC Members
- 4+ student interned in SRC Members





### **Plan of Action: Broadening Student Participation**

- Our Pledge: "Strengthen the connection between undergraduate students and industries. Crafting the individual specific career track for undergraduate, graduate, and postdocs."
- BP Champions: Prof. Tingyi Gu and Ms. Devon McLaurin

#### **Priorities for Year 2**

- Promoting Diversity & Inclusion
  - Invite undergraduate students from Georgia Tech, the University of Delaware, and other partnered Universities to participate in annual reviews and upcoming programs.
  - Funds to support their involvement, encouraging valuable contributions and commitment to our goals.

#### • Enhancing Educational Experiences:

- Fund summer programs at Georgia Tech the University of Delaware and other partnered Universities.
- Provide hands-on learning, exposure to new concepts, and networking opportunities for student growth.

#### Supporting Inclusivity & Diversity

- Invest in undergraduate student participation and summer programs.
- Strengthen commitment to inclusivity and diversity in our organizations.



## Summary

#### • What are we trying to do?

• Develop energy-efficient and trustworthy multi-spectral sensors for autonomy

#### How it's done today? What are the limitations?

- Sensing quality is improved via large and wideband pixel arrays; one array for each modality.
- Continuous sensing and digitization of all pixels in a wideband pixel array leads to large volume of digitized data (Analog Data Deluge) and high sensing/digitization power.
- Different sensors for each modality leads to higher sensing power and system cost.

#### What's new in our approach?

• Our *cognitive* multi-spectral sensors with pixel-level convergence will directly generate trustworthy insights from wideband multi-modal analog signals using closed-loop feedback control of the sensor hardware and feature extraction algorithms.

#### • What if we are successful?

- Multi-modal sensing arrays that eliminate corner-case obstructions in machine perception and more efficiently use resources (data bandwidth and power).
- New research direction in designing "adaptive sensors" that learns to traverse the quality versus
  resource space in evolving environment.









